Linear LED Driver, 24-Channel, Bus Controlled

LV52511MNZ

Overview

The LV52511MN is a serial bus controlled linear low side driver for LEDs (or other loads). The 24 channels are grouped in 3 color blocks (RGB) of 8 channels each. The ON-time for each channel can be programmed by an 8bit register. The reference current is programmed by a single resistor, a 5bit register defines the current for each color block as a fraction (3 to 100%) of the reference current to adjust for color temperature.

Systems parameters can be programmed via 2 wire serial bus, or 3 wire SPI bus with EN, and I²C serial bus format (Hs-mode).

Features

- LED Supply from 3 V to 41 V with Transient Tolerance up to 42 V
- System Supply from 3 V to 20 V with Transient Tolerance up to 24 V
- Up to 60 mA Resistor Defined Maximum Current for All Channels
- 5 bit Individually Adjustable Current for each Color Group RGB
- 8 bit Luminance Dimming for each Channel
- 2 or 3 Wire Bus Interface with up to 56 Slave Addresses
- Thermal and Undervoltage Lock-out Protection
- Thermally Efficient Exposed Die 48 pin QFN Package for Operation up to 85°C Ambient
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

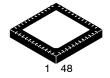
Typical Applications

- Gaming (Slot Machine) and Entertainment Equipment
- LED Displays
- Digital Information Signs



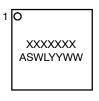
ON Semiconductor®

www.onsemi.com



QFN48 7x7 CASE 485EB

MARKING DIAGRAM



- XXX = Specific Device Code
 - = Assembly Location Code
 - = Wafer Lot Code
 - = Year

AS

WL

YΥ

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
LV52511MNZTXG	QFN48 (Pb-Free/ Halogen Free)	2,500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

1

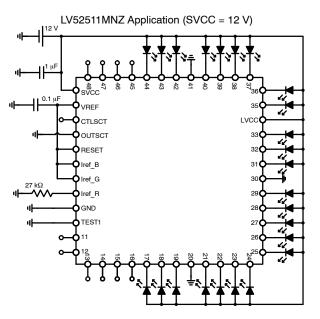


Figure 1. Typical Application Diagram

PINOUT

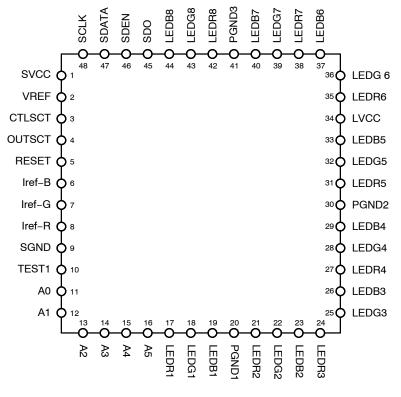


Figure 2. Pin Assignment

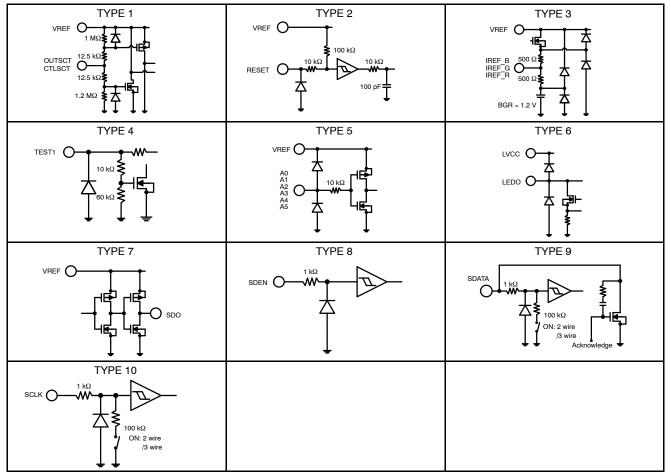
PIN DESCRIPTIONS

Pin No.	Pin Name	I/O	Description	Pin Circuit
1	SVCC	-	System power supply input. For LED supply voltages from 3 to 20 V connect directly to LED supply. For higher LED voltages SVCC must be limited to 24 V (max)	
2	VREF	0	Internal supply output pin. Regulates to 5 V if SVCC is higher than 5 V. Bypass with a 0.1 μF capacitor	
3	CTLSCT	I	Select pin for 2-wire or 3-wire interface and I ² C. Tie to GND for 3-wire, tie to VREF for 2wire bus, open for I ² C bus	TYPE 1
4	OUTSCT	I	Analog three level selection pin to set current characteristics for the output chan- nels. See "OUTSCT Setting" on page 10 for details	TYPE 1
5	RESET	I	Active high reset input pin. Clears all register settings. Power on reset connect with VREF.	TYPE 2
6	Iref_B	0	Maximum reference current programming pin. Connect a resistor > 10 k Ω from this pin to GND to define maximum LED current according to the following formula: IREF = 1.2 × 580 / RT	TYPE 3
7	Iref_G	0	Maximum reference current programming pin. Connect a resistor > 10 k Ω from this pin to GND to define maximum LED current according to the following formula: IREF = 1.2 × 580 / RT	TYPE 3
8	Iref_R	0	Maximum reference current programming pin. Connect a resistor > 10 k Ω from this pin to GND to define maximum LED current according to the following formula: IREF = 1.2 × 580 / RT	TYPE 3
9	SGND	-	Analog circuit GND pin	
10	TEST1	I	Test1 pin (connected to GND)	TYPE 4
11–16	A0-A5	I	Slave address setting pin. Refer to "Slave Address Setting" on page 11 for details	TYPE 5
17	LEDR1	0	LED red 1 current output pin	TYPE 6
18	LEDG1	0	LED green 1 current output pin	TYPE 6
19	LEDB1	0	LED blue 1 current output pin	TYPE 6
20	PGND1	-	GND pin dedicated for LED driver. Connect directly to ground plane	
21	LEDR2	0	LED red 2 current output pin	TYPE 6
22	LEDG2	0	LED green 2 current output pin	TYPE 6
23	LEDB2	0	LED blue 2 current output pin	TYPE 6
24	LEDR3	0	LED red 3 current output pin	TYPE 6
25	LEDG3	0	LED green 3 current output pin	TYPE 6
26	LEDB3	0	LED blue 3 current output pin	TYPE 6
27	LEDR4	0	LED red 4 current output pin	TYPE 6
28	LEDG4	0	LED green 4 current output pin	TYPE 6
29	LEDB4	0	LED blue 4 current output pin	TYPE 6
30	PGND2	-	GND pin dedicated for LED driver. Connect directly to ground plane	
31	LEDR5	0	LED red 5 current output pin	TYPE 6
32	LEDG5	0	LED green 5 current output pin	TYPE 6
33	LEDB5	0	LED blue 5 current output pin	TYPE 6
34	LVCC	-	Protection for LED drivers. For higher LED voltages. LVCC must be limited to 42.0 V (max)	
35	LEDR6	0	LED red 6 current output pin	TYPE 6
36	LEDG6	0	LED green 6 current output pin	TYPE 6

PIN DESCRIPTIONS (continued)

Pin No.	Pin Name	I/O	Description	Pin Circuit
37	LEDB6	0	LED blue 6 current output pin	TYPE 6
38	LEDR7	0	LED red 7 current output pin	TYPE 6
39	LEDG7	0	LED green 7 current output pin	TYPE 6
40	LEDB7	0	LED blue 7 current output pin	TYPE 6
41	PGND3	-	GND pin dedicated for LED driver. Connect directly to ground plane	
42	LEDR8	0	LED red 8 current output pin	TYPE 6
43	LEDG8	0	LED green 8 current output pin	TYPE 6
44	LEDB8	0	LED blue 8 current output pin	TYPE 6
45	SDO	0	Serial interface output pin.	TYPE 7
46	SDEN	Ι	Active high, 3-wire SPI Mode enable signal. Must go low after each SPI frame. Not used for 2 wire interface	TYPE 8
47	SDATA	I/O	Serial interface data input / output pin. Data frame consists of: Slave_Address[7:0] – Register_Address[7:0] – Data1[7:0] … DataN[7:0]	TYPE 9
48	SCLK	I	Serial interface clock signal input pin. Data is latched at the rising clock edge	TYPE 10
	Exposed PAD		Connected to ground plane	

PIN CIRCUIT



SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CC} max	Maximum Supply Voltage		24	V
VLED			42	V
VREF			5.8	V
VO max	Output Voltage	LED off	42	V
IO max	Output Current	SVCC = 5.0 to 20 V	60/80	mA
IO max	Output Current	SVCC = 3.0 to 5 V	30/80	mA
P _d max	Allowable Power Dissipation	$T_A \le 25^{\circ}C$ (Note 1)	4.15	W
T _{opr}	Operating Temperature		-25 to +85	°C
Tj	Operating Junction Temperature		-25 to +150	°C
T _{stg}	Storage Temperature		-40 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Specified board: 110 mm × 90 mm × 1.6 mm, glass epoxy board. Exposed Die-pad area is not a substrate mounting.
If you should intend to use this IC continuously under high temperature, high current, high voltage, or drastic temperature change, even if it is used within the range of absolute maximum ratings or operating conditions, there is a possibility of decrease reliability. Please contact us for a confirmation.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Ratings	Unit
V _{CC} op	Operating Supply Voltage Range	SV _{CC}	3.0 to 20	V
V _{LED} op		LVCC	3.0 to 41	V
V _{REF} op		VREF	3.0 to 5.5	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_A = 25°C, 3.3 V < SVCC < 20 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC} 1	Supply Current1	SVCC = 12 V/RESET = H LED OFF	1.2	1.9	2.6	mA
I _{CC} 2	Supply Current2	SVCC = 12 V/RESET = H LED OFF SCLK = 5 MHz	1.8	3.0	4.2	mA
IMAX1R	LED Driver Output Current Rch	lref-R = 27 kΩ, OUTSCT = L	24.25	25.80	27.35	mA
IMAX1G	LED Driver Output Current Gch	lref-G = 27 kΩ, OUTSCT = L	24.25	25.80	27.35	mA
IMAX1B	LED Driver Output Current Bch	lref-B = 27 kΩ, OUTSCT = L	24.25	25.80	27.35	mA
ΔIL	Line Regulation	$V_{O} = 0.7$ to 4.0 V (Same channel line regulation)	-5	-	-	%
Ron1	LED Output on Resistance 1	I _O = 10 mA	-	10	20	Ω
lleak	OFF Leak Current	LED OFF	-	-	1	μΑ
VPOR	VCC Power on RESET Voltage	POR release voltage threshold	-	2.5	-	V
VRST		Undervoltage lockout threshold	-	2.3	-	V
VREF1	VREF Voltage	SVCC = 12 V, I _O = 30 mA	4.8	5.1	5.4	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Unit Symbol Parameter Conditions Min Тур Max VH1 H Level 1 Input H level OUTSCT/CTLSCT V 4.5 _ 5.0 VM1 M Level 1 Input M level OUTSCT/CTLSCT 3.0 v 1.8 _ VL1 L Level 1 Input L level OUTSCT/CTLSCT 0 0.5 V _ VH2 H Level 2 V Input H level RESET 4.0 5.0 _ V VL2 L Level 2 Input L level RESET 0 _ 1.0 V VH3 H Level 3 Input H level A0 to A5 3.5 5.0 _ VL3 L Level 3 Input L level A0 to A5 0 0.5 V _ VH4 H Level 4 Input H level SCLK, SDATA, SDEN 4.0 5.0 V _ VL4 L Level 4 Input L level SCLK, SDATA, SDEN 0 1.0 V _

CONTROL CIRCUIT ($T_A = 25^{\circ}C$, SVCC = 5.0 to 20 V)

CONTROL CIRCUIT (T_A = 25°C, SVCC = 3.3 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
VH1	H Level 1	Input H level OUTSCT/CTLSCT	2.8	-	3.3	V
VM1	M Level 1	Input M level OUTSCT/CTLSCT	1.2	-	1.8	V
VL1	L Level 1	Input L level OUTSCT/CTLSCT	0	-	0.5	V
VH2	H Level 2	Input H level RESET	2.7	-	3.3	V
VL2	L Level 2	Input L level RESETT	0	-	0.6	V
VH3	H Level 3	Input H level A0 to A5	2.7	-	3.3	V
VL3	L Level 3	Input L level A0 to A5	0	-	0.5	V
VH4	H Level 4	Input H level SCLK, SDATA, SDEN	2.7	-	3.3	V
VL4	L Level 4	Input L level SCLK, SDATA, SDEN	0	-	0.6	V

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
ts0	Data Setup Time	SDEN setup time relative to the rise of SCLK	90	-	-	ns
ts1		SDATA setup time relative to the rise of SCLK	60	-	-	ns
th0	Data Hold Time	SDEN hold time relative to the fall of SCLK	200	-	-	ns
th1		SDATA hold time relative to the fall of SCLK	60	-	-	ns
tw1L	Pulse Width	Low period pulse width of SCLK	90	-	-	ns
tw1H		High period pulse width of SCLK	90	-	-	ns
tw2L		Low period pulse width of SDEN	1	-	-	μs

SERIAL BUS TIMING CONDITIONS AT 2-WIRE SPI, AND 3-WIRE SPI

SERIAL BUS TIMING CONDITIONS AT I²C FAST-MODE PLUS

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
fsc1	SCL Clock Frequency	SCLK clock frequency	0	-	1000	kHz
ts1	Data Setup Time	SCL setup time relative to the rise of SDA	0.26	-	-	μs
ts2		SDA setup time relative to the rise of SCL	50	-	-	ns
ts3		SCL setup time relative to the rise of SDA	0.26	-	-	μs
th1	Data Hold Time	SCL hold time relative to the fall of SDA	-	-	-	μs
th2		SDA hold time relative to the fall of SCL	0	-	-	μs
tw1L	Pulse Width	Low period pulse width of SCL	0.5	-	-	μs
tw1H		High period pulse width of SCL	0.26	-	-	μs
ton	Input Signal	Rise time of both SDA and SCL signals	-	-	120	ns
tof	1	Fall time of both SDA and SCL signals	-	-	120	ns
tbuf	Bus Free Time	Bus free time between a STOP and START condition	0.5	-	-	μs

SERIAL BUS TIMING CONDITIONS AT I²C Hs-MODE

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
fsc1	SCL Clock Frequency	SCLK clock frequency	0	-	3.4	MHz
ts1	Data Setup Time	SCL setup time relative to the rise of SDA	160	-	-	ns
ts2		SDA setup time relative to the rise of SCL	10	-	-	ns
ts3		SCL setup time relative to the rise of SDA	160	-	-	ns
th1	Data Hold Time	SCL hold time relative to the fall of SDA	-	-	-	ns
th2		SDA hold time relative to the fall of SCL	0	-	70	ns
tw1L	Pulse Width	Low period pulse width of SCL	160	-	-	ns
tw1H		High period pulse width of SCL	60	-	-	ns
tcon	Input Signal	Rise time of SCL signals	10	-	40	ns
tcof		Fall time of SCL signals	10	-	40	ns
tdon	1	Rise time of SDA signals	10	-	80	ns
Tdof		Fall time of SDA signals	10	-	80	ns

The ACK sink capability of the SDA pin is equal to FASTMODE. In case of requirement up to 20 mA, an external MOSFET is needed.

DETAILED FUNCTIONAL DESCRIPTION

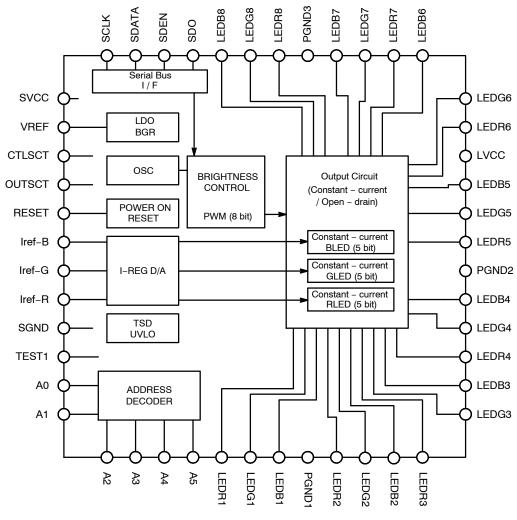


Figure 3. Block Diagram

System Startup and Shutdown (SVCC, RESET)

The LV52511MN is supplied via SVCC. If the voltage on SVCC rises above the POR level of 2.5 V (typ) the system

RESET = H svcc VREF Output = 5.1 V Register data maintair Power ON Reset Power ON Reset Voltage = 2.5 V Reset Voltage = 2.3 V When cancel the reset of the device, it is Detect the UVLO voltage, necessary to remove power-on reset after and internal reset is carried out assuming it SVCC = 0 V SVCC 0 Register data 3 msec - LED output current LVCC 3 msec Serial input (SCLK, SDATA, SDEN) SVCC RESET LVCC 3 msec Serial input (SCLK, SDATA, SDEN)

Figure 4. SVCC Startup and Shutdown

SVCC can be connected to the LED supply of the application as long as that supply is between 3 and 20 V. If the LED supply is higher than 20 V, SVCC must be supplied from a separate source.

If SVCC drops below the undervoltage lockout level of 2.3 V (typ) the system shuts down.

Internal References (SVCC, VREF, Iref-R/G/B)

An internal voltage reference of 5 V (typ) is generated at VREF from SVCC. Do not connect external loads.

setup registers are being reset to their default state, and the

reference internal reference circuit at VREF starts up.

An LED reference current is defined by connecting a resistor R_{RT} between Iref-R/G/B and GND according to the formula: $I_{MAX} = 1.2 \times 580$ / R_{RT} . A fraction of this current (3%-100%) is applied to each LED channel.

Iref-R/G/B Setting	Serial Setting Pin
Iref-R: resistance The variable adjustment of the RGB electric current level by the register is possible by conner resistance to decide a current value to only Iref-R. Iref-B: VREF (for 00h for 01h 02h) Iref-G,Iref-B connects with VREF terminal.	
Iref-R: resistance Iref-G: resistance Iref-B: resistance	The current value of RGB is fixed by connecting resistance to decide a current value to RGB unit. The adjustment of the register is not possible (it becomes fixed in max)

Table 1. INTERNAL REFERENCES

LED Driver Configuration (LEDR1-8, LEDG1-8, LEDB1-8, OUTSCT)

The LEDs are connected between the system LED supply and IC channels LED_R1-R8, LED_G1-G8, LED_B1-B8 such that the LED current flows into the IC. Depending on the LED drive voltage, it is possible to connect a single LED or a chain of LEDs.

The LV52511MN can adjust color temperature and brightness for up to 24 LEDs. Color temperature is adjusted by varying the LED current, and brightness (luminance) is adjusted by varying the on-time of the LED a fixed time period (duty-cycle).

Color Temperature Control

The 24 LED channels are organized into 3 color groups (Red, Green, Blue) of 8 channels each. The currents for each color group are programmed by a 5 bit register as

Table 2. OUTSCT SETTINGS

a percentage of the LED reference current I_{MAX} . Percentages of 3 to 100 of are possible.

Luminance Control

The brightness of each LED channel is defined by the duty cycle Duty(%): the time t_{ON} the channel is active during a time window t_{CYCLE} . The duty cycle is defined by the following formula. Duty(%) = $100 \times t_{ON} / t_{CYCLE}$. Each LED channel has an 8-bit register to vary the duty cycle between OFF (0.0%) and 99.6% in steps of 0.39% each.

OUTSCT Settings

In addition to the settings mentioned above, it is also possible to subdivide the 8 LED channels within the color groups into 6 and 2 LED channels grouped in the following way:

	LED Drive	er Output Pin
OUTSCT Level	LEDR1-R6, LEDG1-G6, LEDB1-B6	LEDR7/R8, LEDG7/G8, LEDB7/B8
L = -0.2 to 0.3 V	Constant current output Set maximum current by built-in D/A (5 bits) 0.81 mA to 25.8 mA, RT1 = 27 k Ω	Same as the other LEDs
H = 4.7 to 5.0 V	Open drain output Set current by external resistor R_{ON} = 10 Ω	Same as the other LEDs
M = 1.8 to 3.0 V	Constant current output Set maximum current by built-in D/A (5 bits) 0.81 mA to 25.8 mA, RT1 = 27 k Ω	Open drain output Set current by external resistor R_{ON} = 10 Ω

Thermal Considerations

Supplying a large number of LEDs from the LV52511MN leads to a rise in chip temperature. The self-heating depends on:

- the drive current I_O flowing into the LED channel
- the voltage at the output V_{OUT} of the LED channel
- and the duty cycle D they are driven with leading to the following formula for dissipated power in each channel:

$$P_{CH} = I_{O} \times V_{OUT} \times D$$
 (eq. 1)

The only architecture sensitive value is V_{OUT} . It must be greater than 0.7 V (min) to allow for regulation, but also as small as possible. It is therefore advisable to connect the maximum possible number of LEDs in series to one channel.

The total power dissipation P_{TOT} of the IC is then the sum of all P_{CH} together. P_{TOT} must not exceed the power allowed by the safe operating are shown in Figure 5.

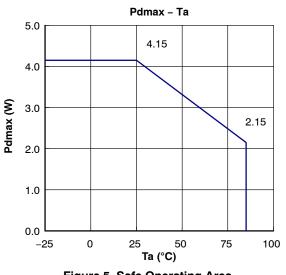


Figure 5. Safe Operating Area



Figure 6. Board

Over Temperature Shutoff

To protect the circuit from permanent damage or fire, overtemperature shutoff is implemented. If the junction temperature of the IC reaches 175°C, all LED outputs are turned OFF. The thermal shut down is not latched, s0 when the temperature falls below 130°C activity resumes.

Serial Bus Communication (SCLK, SDATA, SDEN, CTLSCT)

All parameters described above are written to the LV52511MN via a single directional 2-wire or 3-wire serial bus with a clock frequency of up to 5 MHz. The bus type is defined by the state of pin CTLSCT (VREF = 2-wire, GND = 3-wire). Furthermore, the setting of CTLSCT = M supports I²C. It supports Hs-mode (3.4 MHz).

Each bus message consists of an 8bit slave (IC) address, followed by an 8bit register address, followed by one or more 8bit data words. The register address will self-increment for consecutive data words as long as the communication is valid. After the last address was written, the next data word will be written to address 00h again. For detailed information on addresses and register contents see section"

Table 3. SERIAL SETTING PIN

CTLSCT Level	Serial Setting Pin
L = -0.2 to 0.3 V	3wire SPI serial bus (SCLK, SDATA, SDEN) 5 MHz
H = 4.7 to 5.0 V	2wire SPI serial bus (SCLK, SDATA) 5 MHz
M = 1.8 to 3.0 V	l ² C serial bus (SCLK, SDATA) Hs-mode

Slave Address (A5-A0)

Each IC is identified by its unique slave address. The most significant two bits of the 8bit slave (IC) address are fixed to 10b. 56 Slave addresses are hardware defined by pins A0–A5 as described below.

Table 4. SLA	VE ADDRESS	S (A5–A0)						
	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0
ADDRESS	1	A5	A4	A3	A2	A1	A0	0

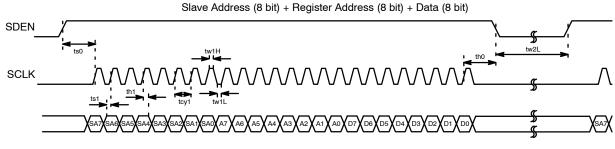
	-	Ferminal F	PIN (Input)		SLAVE ADDRESS								
A5	A4	A3	A2	A1	A0	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0	
L	L	L	L	L	L	1	0	0	0	0	0	0	0	
							A5	A4	A3	A2	A1	A0	0	
Н	Н	L	Н	Н	Н	1	1	1	0	1	1	1	0	

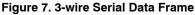
At the time of CTLSCT = L, H, the SLAVE setting is possible to 56.

At the time of CTLSCT = M, the SLAVE setting is possible to 48.

3-wire Serial Bus Communication (SCLK, SDATA, and SDEN)

In 3-wire communication a frame is started with a rising edge of SDEN and terminated with a falling edge of SDEN. SCLK latches data at the rising edge. The smallest data word is 24bits long consisting of: If the number of SCLK transitions is less than 23, Data is not latched. If it is 25 or more, the register address is automatically incremented and the next data word will be latched after eight clock cycles.





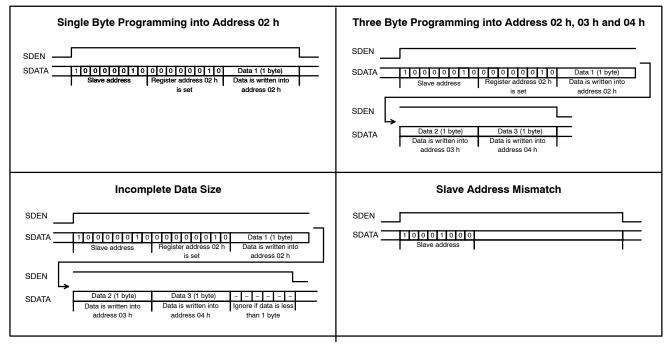


Figure 8. Data Write Examples into Slave 82h

2-wire Serial Bus Communication (SCLK, SDATA)

In 2-wire communication the LV52511MN watches SDATA at every rising SCLK edge. A data frame begins after START condition: nine consecutive detections of a "1" (high) followed by a "0" (BLANK). This is true even during an ongoing data transfer: serial communication will restarted by a START condition ("11111111") + BLANK ("0").

After start detection, the eight bit slave address will be latched after receiving a BLANK (0h) with the ninth bit. The register address will be latched after receiving a BLANK "0" after eight address bits. The third byte is the data byte which was addressed by the register address received before. The data byte will be latched after receiving a BLANK "0" in position nine after eight data bits.

When data bytes continue after this, the register address will be automatically incremented after each byte transfer is completed after receiving BLANK "0".

If the BLANK after a data transfer is "1", including slave address and register address, the single byte data just before it will not be written, and subsequent data is ignored until another START condition is detected.

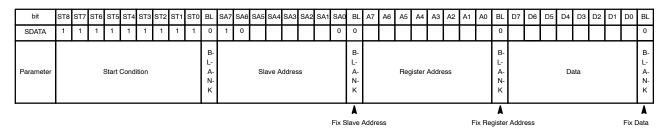


Figure 9. 2-wire Serial Communication Frame

Minimum Data length is 37 bits: Start condition "111111111" (9bit) + BLANK ("0") + Slave address (8bit) + BLANK ("0") + Register address (8bit) + BLANK ("0") + Data (8bit) + BLANK ("0"). NOTE: When SCLK is less than 27th clocks and/or BLANK is "1" instead of "0" after start detection, will not take in SDATA. When SCLK is higher than 28th clock track, start detection is confirmed, register address is incremented every 1 byte (8bit) + BLANK ("0").

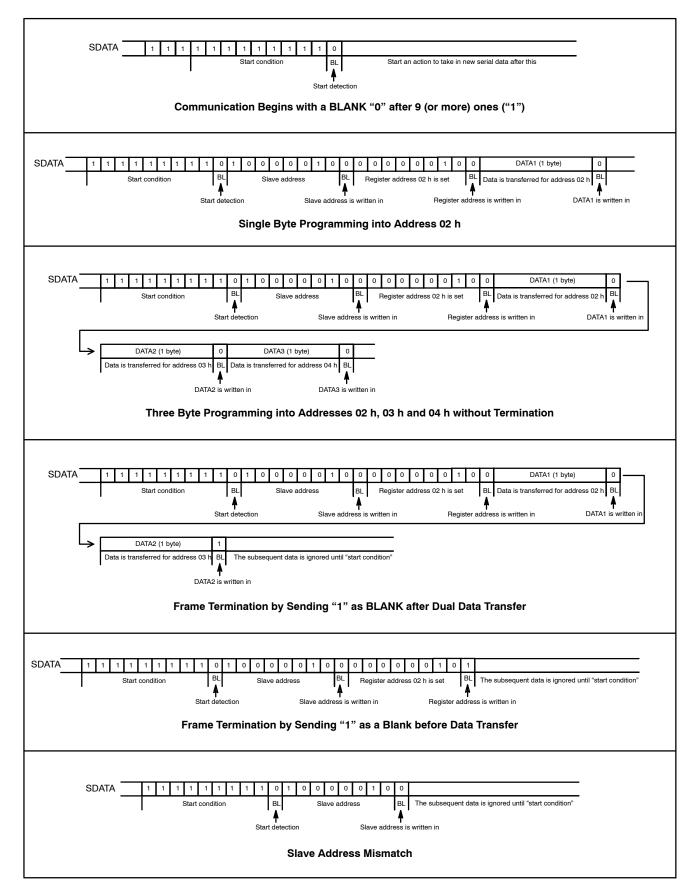
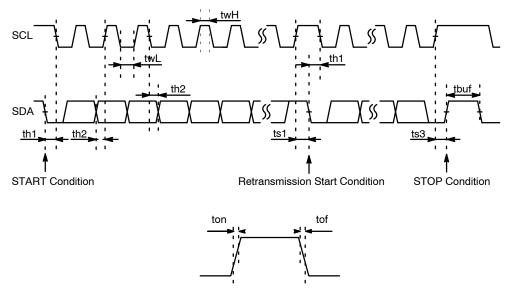


Figure 10. Data Write Examples into Slave 82h

I²C Serial Bus Communication (SCLK, SDATA)

In 2-wire communication, LV52511MN accepts the format corresponding to the standard of I^2C .

It is Fast-mode Plus and higher-speed communicating Hs-mode.



Input signal condition



As for start condition and the stop condition I^2C bus, SCL has that SDA is kept between "H" by the constant state like the chart below during movement performing data transmission basically.

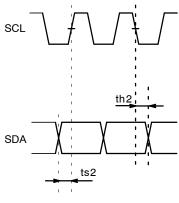
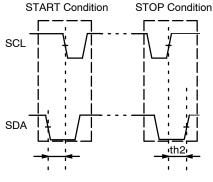


Figure 12.

The READ mode does not support.

In addition, SCL and SDA are in a condition of "H" together when data transmission is not carried out. It becomes, and, at the time of this SCL = SDA = H, access is started by a start condition when I change SDA into L from H.

When SCL changes SDA into "H" from "L" at the time of H, it becomes a stop condition and becomes the end of the access.





REGISTER MAP

After POR all registers are cleared.

Table 5. COLOR TEMPERATURE REGISTERS

Addr.	Register	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]		Description
00h	LEDR Current					I_	LEDR[4:	0]		LEDR Curre	ent Setting (LEDR1~LEDR8)
		0	0	0	0	0	0	0	0	3% of Imax	(0.81 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	0	1	6% of Imax	(1.61 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	1	0	9% of Imax	(2.42 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	1	1	13% of Imax	(3.23 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	0	0	16% of Imax	(4.03 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	0	1	19% of Imax	(4.84 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	1	0	22% of Imax	(5.64 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	1	1	25% of Imax	(6.45 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	0	0	28% of Imax	(7.26 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	0	1	31% of Imax	(8.06 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	1	0	34% of Imax	(8.87 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	1	1	38% of Imax	(9.68 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	0	0	41% of Imax	(10.48 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	0	1	44% of Imax	(11.29 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	1	0	47% of Imax	(12.09 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	1	1	50% of Imax	(12.90 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	0	0	53% of Imax	(13.71 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	0	1	56% of Imax	(14.51 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	1	0	59% of Imax	(15.32 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	1	1	63% of Imax	(16.13 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	0	0	66% of Imax	(16.93 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	0	1	69% of Imax	(17.74 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	1	0	72% of Imax	(18.54 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	1	1	75% of Imax	(19.35 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	0	0	78% of Imax	(20.16 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	0	1	81% of Imax	(20.96 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	1	0	84% of Imax	(21.77 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	1	1	88% of Imax	(22.58 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	0	0	91% of Imax	(23.38 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	0	1	94% of Imax	(24.19 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	1	0	97% of Imax	(24.99 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	1	1	Imax	(25.80 mA @ RT = 27 kΩ)
01h	LEDG Current					I_	LEDG[4:	0]	•	LEDG Curre	nt Setting (LEDG1~LEDG8)
		0	0	0	0	0	0	0	0	3% of Imax	(0.81 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	0	1	6% of Imax	(1.61 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	1	0	9% of Imax	(2.42 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	1	1	13% of Imax	(3.23 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	0	0	16% of Imax	(4.03 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	0	1	19% of Imax	(4.84 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	1	0	22% of Imax	(5.64 mA @ RT = 27 kΩ)

Addr.	Register	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]		Description
		0	0	0	0	0	1	1	1	25% of Imax	(6.45 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	0	0	28% of Imax	(7.26 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	0	1	31% of Imax	(8.06 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	1	0	34% of Imax	(8.87 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	1	1	38% of Imax	(9.68 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	0	0	41% of Imax	(10.48 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	0	1	44% of Imax	(11.29 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	1	0	47% of Imax	(12.09 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	1	1	50% of Imax	(12.90 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	0	0	53% of Imax	(13.71 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	0	1	56% of Imax	(14.51 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	1	0	59% of Imax	(15.32 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	1	1	63% of Imax	(16.13 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	0	0	66% of Imax	(16.93 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	0	1	69% of Imax	(17.74 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	1	0	72% of Imax	(18.54 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	1	1	75% of Imax	(19.35 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	0	0	78% of Imax	(20.16 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	0	1	81% of Imax	(20.96 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	1	0	84% of Imax	(21.77 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	1	1	88% of Imax	(22.58 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	0	0	91% of Imax	(23.38 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	0	1	94% of Imax	(24.19 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	1	0	97% of Imax	(24.99 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	1	1	Imax	(25.80 mA @ RT = 27 kΩ)
02h	LEDB Current				I LEDB[4:0]					LEDB Curre	nt Setting (LEDB1~LEDB8)
		0	0	0	0	0	0	0	0	3% of Imax	(0.81 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	0	1	6% of Imax	(1.61 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	1	0	9% of Imax	(2.42 mA @ RT = 27 kΩ)
		0	0	0	0	0	0	1	1	13% of Imax	(3.23 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	0	0	16% of Imax	(4.03 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	0	1	19% of Imax	(4.84 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	1	0	22% of Imax	(5.64 mA @ RT = 27 kΩ)
		0	0	0	0	0	1	1	1	25% of Imax	(6.45 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	0	0	28% of Imax	(7.26 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	0	1	31% of Imax	(8.06 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	1	0	34% of Imax	(8.87 mA @ RT = 27 kΩ)
		0	0	0	0	1	0	1	1	38% of Imax	(9.68 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	0	0	41% of Imax	(10.48 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	0	1	44% of Imax	(11.29 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	1	0	47% of Imax	(12.09 mA @ RT = 27 kΩ)
		0	0	0	0	1	1	1	1	50% of Imax	(12.90 mA @ RT = 27 kΩ)
		0	0	0	1	0	0	0	0	53% of Imax	$(13.71 \text{ mA } @ \text{RT} = 27 \text{ k}\Omega)$
		0	0	0	1	0	0	0	1	56% of Imax	(14.51 mA @ RT = 27 kΩ)
		•		Ľ							(

Table 5. COLOR TEMPERATURE REGISTERS (continued)

Addr.	Register	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]		Description
		0	0	0	1	0	0	1	1	63% of Imax	(16.13 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	0	0	66% of Imax	(16.93 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	0	1	69% of Imax	(17.74 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	1	0	72% of Imax	(18.54 mA @ RT = 27 kΩ)
		0	0	0	1	0	1	1	1	75% of Imax	(19.35 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	0	0	78% of Imax	(20.16 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	0	1	81% of Imax	(20.96 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	1	0	84% of Imax	(21.77 mA @ RT = 27 kΩ)
		0	0	0	1	1	0	1	1	88% of Imax	(22.58 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	0	0	91% of Imax	(23.38 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	0	1	94% of Imax	(24.19 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	1	0	97% of Imax	(24.99 mA @ RT = 27 kΩ)
		0	0	0	1	1	1	1	1	Imax	(25.80 mA @ RT = 27 kΩ)

Table 5. COLOR TEMPERATURE REGISTERS (continued)

Table 6. LUMINANCE REGISTERS

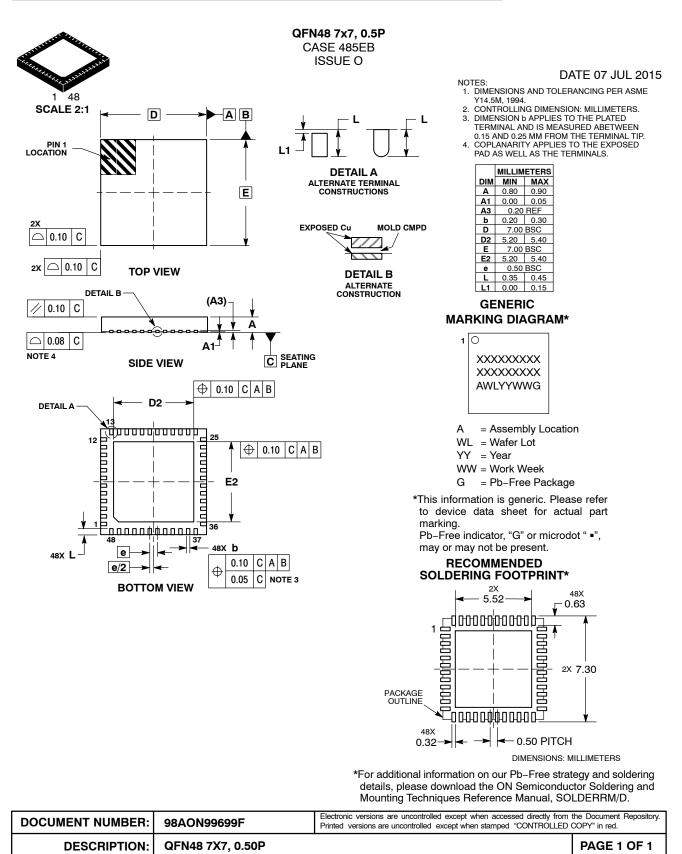
Addr.	Register	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Description
03h	PWM SEL	R8	R7	R6	R5	R4	R3	R2	R1	Select PWM or Full on for LEDR1~LEDR8
	LEDR	0 1	0 1	0 1	0 1	0 1	0 1	0 1	0 1	0: PWM mode 1: Full on (100% PWM)
04h	PWM SEL	G8	G7	G6	G5	G4	G3	G2	G1	Select PWM or Full on for LEDG1~LEDG8
	LEDG	0 1	0 1	0 1	0 1	0 1	0 1	0 1	0 1	0: PWM mode 1: Full on (100% PWM)
05h	05h PWM SEL LEDB	B8	B7	B6	B5	B4	B3	B2	B1	Select PWM or Full on for LEDB1~LEDB8
	LEDB	0 1	0 1	0 1	0 1	0 1	0 1	0 1	0 1	0: PWM mode 1: Full on (100% PWM)
06h	LEDR1 Duty	R1[7]	R1[6]	R1[5]	R1[4]	R1[3]	R1[2]	R1[1]	R1[0]	PWM duty setting for LEDR1
		0	0	0	0	0	0	0	0	Duty(%) = 0.0%
					R1[7:0]	Duty(%) = R1[7:0] / 256			
		1	1	1	1	1	1	1	1	Duty(%) = 99.6%
07h	LEDG1 Duty				G1	7:0]	Duty(%) = G1[7:0] / 256			
08h	LEDB1 Duty				B1[7:0]	Duty(%) = B1[7:0] / 256			
09h	LEDR2 Duty				R2[7:0]	Duty(%) = R2[7:0] / 256			
0ah	LEDG2 Duty				G2	7:0]	Duty(%) = G2[7:0] / 256			
0bh	LEDB2 Duty				B2[7:0]				Duty(%) = B2[7:0] / 256
0ch	LEDR3 Duty				R3[7:0]				Duty(%) = R3[7:0] / 256
0dh	LEDG3 Duty				G3	7:0]				Duty(%) = G3[7:0] / 256
0eh	LEDB3 Duty				B3[7:0]				Duty(%) = B3[7:0] / 256
0fh	LEDR4 Duty				R4[7:0]				Duty(%) = R4[7:0] / 256
10h	LEDG4 Duty				G4[7:0]				Duty(%) = G4[7:0] / 256
11h	LEDB4 Duty				B4[7:0]				Duty(%) = B4[7:0] / 256
12h	LEDR5 Duty				R5[7:0]				Duty(%) = R5[7:0] / 256
13h	LEDG5 Duty				G5[7:0]				Duty(%) = G5[7:0] / 256
14h	LEDB5 Duty				B5[7:0]				Duty(%) = B5[7:0] / 256
15h	LEDR6 Duty				R6[7:0]				Duty(%) = R6[7:0] / 256
16h	LEDG6 Duty				G6[7:0]				Duty(%) = G6[7:0] / 256
17h	LEDB6 Duty				B6[7:0]				Duty(%) = B6[7:0] / 256

Table 6. LUMINANCE REGISTERS (continued)

Addr.	Register	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Description			
18h	LEDR7 Duty				R7[7:0]	Duty(%) = R7[7:0] / 256						
19h	LEDG7 Duty				G7[7:0]	Duty(%) = G7[7:0] / 256						
1ah	LEDB7 Duty				B7[7:0]	Duty(%) = B7[7:0] / 256						
1bh	LEDR8 Duty				R8[7:0]	Duty(%) = R8[7:0] / 256						
1ch	LEDG8 Duty				G8[7:0]	Duty(%) = G8[7:0] / 256						
1dh	LEDB8 Duty				B8[7:0]	Duty(%) = B8[7:0] / 256						
1eh													
1fh													
20h	Group1 Duty			R1/R2/	/R3/R4/R	5/R6/R7/	R8[7:0]			Duty(%) = Group1 [7:0] / 256			
21h	Group2 Duty			G1/G2/	G3/G4/G	5/G6/G7	G8[7:0]			Duty(%) = Group2 [7:0] / 256			
22h	Group3 Duty			B1/B2	/B3/B4/B	5/B6/B7/	38[7:0]			Duty(%) = Group3 [7:0] / 256			
23h	Group4 Duty			R1,	/G1/B1/R	2/G2/B2[Duty(%) = Group4 [7:0] / 256						
24h	Group5 Duty			R3,	/G3/B3/R	4/G4/B4[Duty(%) = Group5 [7:0] / 256						
25h	Group6 Duty			R5/	/G5/B5/R	6/G6/B6[Duty(%) = Group6 [7:0] / 256						
26h	Group7 Duty			R7,	/G7/B7/R	8/G8/B8[7:0]			Duty(%) = Group7 [7:0] / 256			

When you transmit data of the group setting. please be careful because data of the individual setting update it.





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>